

## SNx4HC244 Octal Buffers and Line Drivers With 3-State Outputs

### 1 Features

- Wide operating voltage range of 2V to 6V
- High-current outputs drive up to 15 LSTTL loads
- 3-state outputs drive bus lines or buffer memory address registers
- Low power consumption:  $I_{CC}$ , 80 $\mu$ A (maximum)
- Typical  $t_{pd}$  = 11ns
- $\pm 6$ mA output drive at 5V
- Low input current of 1 $\mu$ A (maximum)
- On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

### 2 Applications

- Servers
- LED Displays
- Network Switches
- Telecom Infrastructure
- Motor Drivers
- I/O Expanders

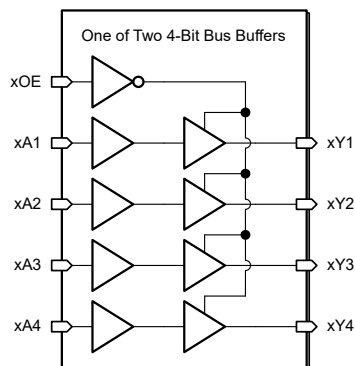
### 3 Description

The SNx4HC244 octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The SNx4HC244 devices are organized as two 4-bit buffers and drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$  is low, the device passes noninverted data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

#### Package Information

| PART NUMBER | PACKAGE <sup>(1)</sup> | PACKAGE SIZE <sup>(2)</sup> | BODY SIZE <sup>(3)</sup> |
|-------------|------------------------|-----------------------------|--------------------------|
| SN54HC244   | J (CDIP, 20)           | 24.38mm × 7.62mm            | 24.38mm × 6.92mm         |
|             | W (CFP, 20)            | 13.72mm × 8.13mm            | 13.72mm × 6.92mm         |
|             | FK (LCCC, 20)          | 8.89mm × 8.89mm             | 8.89mm × 8.89mm          |
| SN74HC244   | DB (SSOP, 20)          | 7.2mm × 7.8mm               | 7.2mm × 5.3mm            |
|             | DW (SOIC, 20)          | 12.80mm × 10.3mm            | 12.8mm × 7.5mm           |
|             | N (PDIP, 20)           | 24.33mm × 9.4mm             | 24.33mm × 6.35mm         |
|             | NS (SOP, 20)           | 12.6mm × 7.8mm              | 12.6mm × 5.3mm           |
|             | PW (TSSOP, 20)         | 6.5mm × 6.4mm               | 6.5mm × 4.4mm            |

- (1) For more information, see [Mechanical, Packaging, and Orderable Information](#).
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.
- (3) The body size (length × width) is a nominal value and does not include pins.



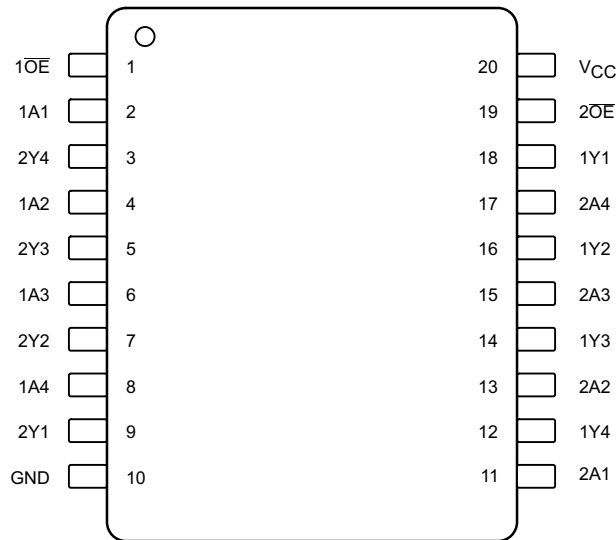
Logic Diagram (Positive Logic)



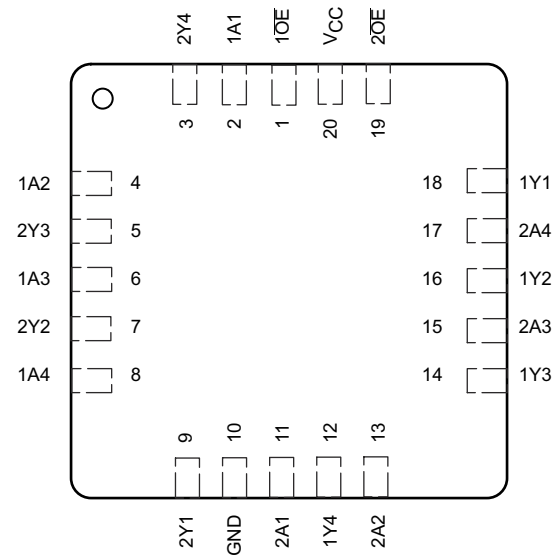
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## 4 Pin Configuration and Functions



**Figure 4-1. DB, DW, J, N, NS, PW, W Package 20-Pin SSOP, SOIC, CDIP, PDIP, SOP, TSSOP, or CFP Top View**



**Figure 4-2. FK Package 20-Pin LCCC Top View**

| PIN               |     | TYPE <sup>(1)</sup> | DESCRIPTION   |
|-------------------|-----|---------------------|---------------|
| NAME              | NO. |                     |               |
| 1A1               | 2   | I                   | Input         |
| 1A2               | 4   | I                   | Input         |
| 1A3               | 6   | I                   | Input         |
| 1A4               | 8   | I                   | Input         |
| 1 $\overline{OE}$ | 1   | I                   | Output Enable |
| 1Y1               | 18  | O                   | Output        |
| 1Y2               | 16  | O                   | Output        |
| 1Y3               | 14  | O                   | Output        |
| 1Y4               | 12  | O                   | Output        |
| 2A1               | 11  | I                   | Input         |
| 2A2               | 13  | I                   | Input         |
| 2A3               | 15  | I                   | Input         |
| 2A4               | 17  | I                   | Input         |
| 2 $\overline{OE}$ | 19  | I                   | Output Enable |
| 2Y1               | 9   | O                   | Output        |
| 2Y2               | 7   | O                   | Output        |
| 2Y3               | 5   | O                   | Output        |
| 2Y4               | 3   | O                   | Output        |
| GND               | 10  | —                   | Ground        |
| V <sub>CC</sub>   | 20  | —                   | Power Pin     |

(1) Signal Types: I = Input, O = Output

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|  |  | MIN  | MAX | UNIT |
|--|--|------|-----|------|
| Supply voltage range, $V_{CC}$             |  | -0.5 | 7   | V    |
| Input clamp current, $I_{IK}$              | $V_I < 0$ or $V_I > V_{CC}$ <sup>(2)</sup> |      | ±20 | mA   |
| Output clamp current, $I_{OK}$             | $V_O < 0$ or $V_O > V_{CC}$ <sup>(2)</sup> |      | ±20 | mA   |
| Continuous output current, $I_O$           | $V_O = 0$ or $V_{CC}$                      |      | ±35 | mA   |
| Continuous current through $V_{CC}$ or GND |  |      | ±70 | mA   |
| Junction Temperature, $T_J$                |  |      | 150 | °C   |
| Storage temperature, $T_{stg}$             |  | -65  | 150 | °C   |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

### 5.2 ESD Ratings

|                                     |  | SN74HC244 | VALUE | UNIT |
|-------------------------------------|--|-----------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              |           | ±2000 | V    |
|                                     | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> |           | ±1000 |      |

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|   |                 | MIN  | NOM | MAX      | UNIT |
|---|-----------------|------|-----|----------|------|
| $V_{CC}$ Supply voltage   |                 | 2    | 5   | 6        | V    |
| $V_{IH}$ High-level input voltage                                     | $V_{CC} = 2V$   | 1.5  |     |          | V    |
|   | $V_{CC} = 4.5V$ | 3.15 |     |          |      |
|   | $V_{CC} = 6V$   | 4.2  |     |          |      |
| $V_{IL}$ Low-level input voltage                                      | $V_{CC} = 2V$   |      |     | 0.5      | V    |
|   | $V_{CC} = 4.5V$ |      |     | 1.35     |      |
|   | $V_{CC} = 6V$   |      |     | 1.8      |      |
| $V_I$ Input voltage   |                 | 0    |     | $V_{CC}$ | V    |
| $V_O$ Output voltage  |                 | 0    |     | $V_{CC}$ | V    |
| $\Delta t/\Delta v$ Input transition rise and fall time               | $V_{CC} = 2V$   |      |     | 1000     | ns/V |
|   | $V_{CC} = 4.5V$ |      |     | 500      |      |
|   | $V_{CC} = 6V$   |      |     | 400      |      |
| $C_{pd}$ Power dissipation capacitance per buffer or driver (no load) |                 |      | 35  |          | pF   |
| $T_A$ Operating free-air temperature                                  | SN54HC244       | -55  |     | 125      | °C   |
|   | SN74HC244       | -40  |     | 125      |      |

- (1) All unused inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application note, [Implications of Slow or Floating CMOS Inputs](#).

## 5.4 Thermal Information

| THERMAL METRIC         |   | SN74HC244 |           |          |         |            | UNIT |
|------------------------|---|-----------|-----------|----------|---------|------------|------|
|                        |   | DW (SOIC) | DB (SSOP) | N (PDIP) | NS (SO) | PW (TSSOP) |      |
|                        |   | 20 PINS   | 20 PINS   | 20 PINS  | 20 PINS | 20 PINS    |      |
| R <sub>θJA</sub>       | Junction-to-ambient thermal resistance <sup>(1)</sup> | 109.1     | 122.7     | 84.6     | 113.4   | 131.8      | °C/W |
| R <sub>θJC (top)</sub> | Junction-to-case (top) thermal resistance             | 76        | 81.6      | 72.5     | 78.6    | 72.2       | °C/W |
| R <sub>θJB</sub>       | Junction-to-board thermal resistance                  | 77.6      | 77.5      | 65.3     | 78.4    | 82.8       | °C/W |
| Ψ <sub>JT</sub>        | Junction-to-top characterization parameter            | 51.5      | 46.1      | 55.3     | 47.1    | 21.5       | °C/W |
| Ψ <sub>JB</sub>        | Junction-to-board characterization parameter          | 77.1      | 77.1      | 65.2     | 78.1    | 82.4       | °C/W |
| R <sub>θJC (bot)</sub> | Junction-to-case (bottom) thermal resistance          | N/A       | N/A       | N/A      | N/A     | N/A        | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics application note](#).

## 5.5 Electrical Characteristics

T<sub>A</sub> = 25°C (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS   |  | MIN                    | TYP   | MAX   | UNIT |
|-----------------|---|--|------------------------|-------|-------|------|
| V <sub>OH</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   | I <sub>OH</sub> = -20 μA                       | V <sub>CC</sub> = 2V   | 1.9   | 1.998 | V    |
|                 |   |  | V <sub>CC</sub> = 4.5V | 4.4   | 4.499 |      |
|                 |   |  | V <sub>CC</sub> = 6V   | 5.9   | 5.999 |      |
|                 |   | I <sub>OH</sub> = -6mA, V <sub>CC</sub> = 4.5V | 3.98                   | 4.3   |       |      |
|                 |   | I <sub>OH</sub> = -7.8mA, V <sub>CC</sub> = 6V | 5.48                   | 5.8   |       |      |
| V <sub>OL</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>   | I <sub>OL</sub> = 20 μA                        | V <sub>CC</sub> = 2V   | 0.002 | 0.1   | V    |
|                 |   |  | V <sub>CC</sub> = 4.5V | 0.001 | 0.1   |      |
|                 |   |  | V <sub>CC</sub> = 6V   | 0.001 | 0.1   |      |
|                 |   | I <sub>OL</sub> = 6mA, V <sub>CC</sub> = 4.5V  | 0.17                   | 0.26  |       |      |
|                 |   | I <sub>OL</sub> = 7.8mA, V <sub>CC</sub> = 6V  | 0.15                   | 0.26  |       |      |
| I <sub>I</sub>  | V <sub>I</sub> = V <sub>CC</sub> or 0, V <sub>CC</sub> = 6V   |  |                        | ±0.1  | ±100  | nA   |
| I <sub>OZ</sub> | V <sub>O</sub> = V <sub>CC</sub> or 0, V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> , V <sub>CC</sub> = 6V |  |                        | ±0.01 | ±0.5  | μA   |
| I <sub>CC</sub> | V <sub>I</sub> = V <sub>CC</sub> or 0, I <sub>O</sub> = 0, V <sub>CC</sub> = 6V                                   |  |                        |       | 8     | μA   |
| C <sub>i</sub>  | V <sub>CC</sub> = 2V to 6V  |  |                        | 3     | 10    | pF   |

## 5.6 Electrical Characteristics – -55°C – 125°C

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       | TEST CONDITIONS                                     |  | MIN                    | TYP | MAX | UNIT |
|-----------------|---|--|------------------------|-----|-----|------|
| V <sub>OH</sub> | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = -20 μA                       | V <sub>CC</sub> = 2V   | 1.9 |     | V    |
|                 |   |  | V <sub>CC</sub> = 4.5V | 4.4 |     |      |
|                 |   |  | V <sub>CC</sub> = 6V   | 5.9 |     |      |
|                 |   | I <sub>OH</sub> = -6mA, V <sub>CC</sub> = 4.5V | 3.7                    |     |     |      |
|                 |   | I <sub>OH</sub> = -7.8mA, V <sub>CC</sub> = 6V | 5.2                    |     |     |      |

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS   |                               | MIN             | TYP | MAX        | UNIT    |
|-----------|---|-------------------------------|-----------------|-----|------------|---------|
| $V_{OL}$  | $V_I = V_{IH}$ or $V_{IL}$                                      | $I_{OL} = 20\mu A$            | $V_{CC} = 2V$   |     | 0.1        | V       |
|           |   |                               | $V_{CC} = 4.5V$ |     | 0.1        |         |
|           |   |                               | $V_{CC} = 6V$   |     | 0.1        |         |
|           |   | $I_{OL} = 6mA, V_{CC} = 4.5V$ |                 |     | 0.4        |         |
|           |   | $I_{OL} = 7.8mA, V_{CC} = 6V$ |                 |     | 0.4        |         |
| $I_I$     | $V_I = V_{CC}$ or 0, $V_{CC} = 6V$                              |                               |                 |     | $\pm 1000$ | nA      |
| $I_{OZ}$  | $V_O = V_{CC}$ or 0, $V_I = V_{IH}$ or $V_{IL}$ , $V_{CC} = 6V$ |                               |                 |     | $\pm 10$   | $\mu A$ |
| $I_{CC}$  | $V_I = V_{CC}$ or 0, $I_O = 0$ , $V_{CC} = 6V$                  |                               |                 |     | 160        | $\mu A$ |
| $C_i$     | $V_{CC} = 2V$ to $6V$   |                               |                 |     | 10         | pF      |

## 5.7 Electrical Characteristics – -40°C – 125°C

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS   |                                | MIN             | TYP | MAX        | UNIT    |
|-----------|---|--------------------------------|-----------------|-----|------------|---------|
| $V_{OH}$  | $V_I = V_{IH}$ or $V_{IL}$                                      | $I_{OH} = -20\mu A$            | $V_{CC} = 2V$   | 1.9 |            | V       |
|           |   |                                | $V_{CC} = 4.5V$ | 4.4 |            |         |
|           |   |                                | $V_{CC} = 6V$   | 5.9 |            |         |
|           |   | $I_{OH} = -6mA, V_{CC} = 4.5V$ |                 | 3.7 |            |         |
|           |   | $I_{OH} = -7.8mA, V_{CC} = 6V$ |                 | 5.2 |            |         |
| $V_{OL}$  | $V_I = V_{IH}$ or $V_{IL}$                                      | $I_{OL} = 20\mu A$             | $V_{CC} = 2V$   |     | 0.1        | V       |
|           |   |                                | $V_{CC} = 4.5V$ |     | 0.1        |         |
|           |   |                                | $V_{CC} = 6V$   |     | 0.1        |         |
|           |   | $I_{OL} = 6mA, V_{CC} = 4.5V$  |                 |     | 0.4        |         |
|           |   | $I_{OL} = 7.8mA, V_{CC} = 6V$  |                 |     | 0.4        |         |
| $I_I$     | $V_I = V_{CC}$ or 0, $V_{CC} = 6V$                              |                                |                 |     | $\pm 1000$ | nA      |
| $I_{OZ}$  | $V_O = V_{CC}$ or 0, $V_I = V_{IH}$ or $V_{IL}$ , $V_{CC} = 6V$ |                                |                 |     | $\pm 10$   | $\mu A$ |
| $I_{CC}$  | $V_I = V_{CC}$ or 0, $I_O = 0$ , $V_{CC} = 6V$                  |                                |                 |     | 160        | $\mu A$ |
| $C_i$     | $V_{CC} = 2V$ to $6V$   |                                |                 |     | 10         | pF      |

## 5.8 Electrical Characteristics – -40°C – 85°C

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS   |                                | MIN             | TYP  | MAX        | UNIT    |
|-----------|---|--------------------------------|-----------------|------|------------|---------|
| $V_{OH}$  | $V_I = V_{IH}$ or $V_{IL}$                                      | $I_{OH} = -20\mu A$            | $V_{CC} = 2V$   | 1.9  |            | V       |
|           |   |                                | $V_{CC} = 4.5V$ | 4.4  |            |         |
|           |   |                                | $V_{CC} = 6V$   | 5.9  |            |         |
|           |   | $I_{OH} = -6mA, V_{CC} = 4.5V$ |                 | 3.84 |            |         |
|           |   | $I_{OH} = -7.8mA, V_{CC} = 6V$ |                 | 5.34 |            |         |
| $V_{OL}$  | $V_I = V_{IH}$ or $V_{IL}$                                      | $I_{OL} = 20\mu A$             | $V_{CC} = 2V$   |      | 0.1        | V       |
|           |   |                                | $V_{CC} = 4.5V$ |      | 0.1        |         |
|           |   |                                | $V_{CC} = 6V$   |      | 0.1        |         |
|           |   | $I_{OL} = 6mA, V_{CC} = 4.5V$  |                 |      | 0.33       |         |
|           |   | $I_{OL} = 7.8mA, V_{CC} = 6V$  |                 |      | 0.33       |         |
| $I_I$     | $V_I = V_{CC}$ or 0, $V_{CC} = 6V$                              |                                |                 |      | $\pm 1000$ | nA      |
| $I_{OZ}$  | $V_O = V_{CC}$ or 0, $V_I = V_{IH}$ or $V_{IL}$ , $V_{CC} = 6V$ |                                |                 |      | $\pm 5$    | $\mu A$ |
| $I_{CC}$  | $V_I = V_{CC}$ or 0, $I_O = 0$ , $V_{CC} = 6V$                  |                                |                 |      | 80         | $\mu A$ |

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS       | MIN | TYP | MAX | UNIT |
|-----------|-----------------------|-----|-----|-----|------|
| $C_i$     | $V_{CC} = 2V$ to $6V$ |     |     | 10  | pF   |

## 5.9 Switching Characteristics

 $T_A = 25^\circ C$  (unless otherwise noted; see [Figure 6-1](#))

| PARAMETER | TEST CONDITIONS                            |                 | MIN           | TYP | MAX | UNIT |
|-----------|--|-----------------|---------------|-----|-----|------|
| $t_{pd}$  | From A (input) to Y (output)               | $V_{CC} = 2V$   | $C_L = 50pF$  | 40  | 115 | ns   |
|           |  |                 | $C_L = 150pF$ | 56  | 165 |      |
|           |  | $V_{CC} = 4.5V$ | $C_L = 50pF$  | 13  | 23  |      |
|           |  |                 | $C_L = 150pF$ | 18  | 33  |      |
|           |  | $V_{CC} = 6V$   | $C_L = 50pF$  | 11  | 20  |      |
|           |  |                 | $C_L = 150pF$ | 15  | 28  |      |
| $t_{en}$  | From $\overline{OE}$ (input) to Y (output) | $V_{CC} = 2V$   | $C_L = 50pF$  | 75  | 150 | ns   |
|           |  |                 | $C_L = 150pF$ | 100 | 200 |      |
|           |  | $V_{CC} = 4.5V$ | $C_L = 50pF$  | 15  | 30  |      |
|           |  |                 | $C_L = 150pF$ | 20  | 40  |      |
|           |  | $V_{CC} = 6V$   | $C_L = 50pF$  | 13  | 26  |      |
|           |  |                 | $C_L = 150pF$ | 17  | 34  |      |
| $t_{dis}$ | From $\overline{OE}$ (input) to Y (output) | $V_{CC} = 2V$   | $C_L = 50pF$  | 75  | 150 | ns   |
|           |  | $V_{CC} = 4.5V$ | $C_L = 50pF$  | 15  | 30  |      |
|           |  | $V_{CC} = 6V$   | $C_L = 50pF$  | 13  | 26  |      |
| $t_t$     | To Y (output)                              | $V_{CC} = 2V$   | $C_L = 50pF$  | 28  | 60  | ns   |
|           |  |                 | $C_L = 150pF$ | 45  | 210 |      |
|           |  | $V_{CC} = 4.5V$ | $C_L = 50pF$  | 8   | 12  |      |
|           |  |                 | $C_L = 150pF$ | 17  | 42  |      |
|           |  | $V_{CC} = 6V$   | $C_L = 50pF$  | 6   | 10  |      |
|           |  |                 | $C_L = 150pF$ | 13  | 36  |      |

## 5.10 Switching Characteristics – $C_L = 50\text{pF}$

over recommended operating free-air temperature range (unless otherwise noted; see [Figure 6-1](#))

| PARAMETER | TEST CONDITIONS                            |                        | MIN  | TYP | MAX | UNIT |
|-----------|--|------------------------|--|-----|-----|------|
| $t_{pd}$  | From A (input) to Y (output)               | $V_{CC} = 2\text{V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 170 | ns   |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 170 |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 145 |      |
|           |  | $V_{CC} = 4.5\text{V}$ | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 34  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 34  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 29  |      |
|           |  | $V_{CC} = 6\text{V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 29  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 29  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 25  |      |
| $t_{en}$  | From $\overline{OE}$ (input) to Y (output) | $V_{CC} = 2\text{V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 225 | ns   |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 225 |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 190 |      |
|           |  | $V_{CC} = 4.5\text{V}$ | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 45  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 45  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 38  |      |
|           |  | $V_{CC} = 6\text{V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 38  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 38  |      |
|           |  |                        | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 32  |      |

over recommended operating free-air temperature range (unless otherwise noted; see [Figure 6-1](#))

| PARAMETER | TEST CONDITIONS                            |                 | MIN                                  | TYP | MAX | UNIT |
|-----------|--|-----------------|--------------------------------------|-----|-----|------|
| $t_{dis}$ | From $\overline{OE}$ (input) to Y (output) | $V_{CC} = 2V$   | $T_A = -55^\circ C$ to $125^\circ C$ |     | 225 | ns   |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 225 |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 190 |      |
|           |  | $V_{CC} = 4.5V$ | $T_A = -55^\circ C$ to $125^\circ C$ |     | 45  |      |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 45  |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 38  |      |
|           |  | $V_{CC} = 6V$   | $T_A = -55^\circ C$ to $125^\circ C$ |     | 38  |      |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 38  |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 32  |      |
| $t_t$     | To Y (output)                              | $V_{CC} = 2V$   | $T_A = -55^\circ C$ to $125^\circ C$ |     | 90  | ns   |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 90  |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 75  |      |
|           |  | $V_{CC} = 4.5V$ | $T_A = -55^\circ C$ to $125^\circ C$ |     | 18  |      |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 18  |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 15  |      |
|           |  | $V_{CC} = 6V$   | $T_A = -55^\circ C$ to $125^\circ C$ |     | 15  |      |
|           |  |                 | $T_A = -40^\circ C$ to $125^\circ C$ |     | 15  |      |
|           |  |                 | $T_A = -40^\circ C$ to $85^\circ C$  |     | 13  |      |

## 5.11 Switching Characteristics – $C_L = 150\text{pF}$

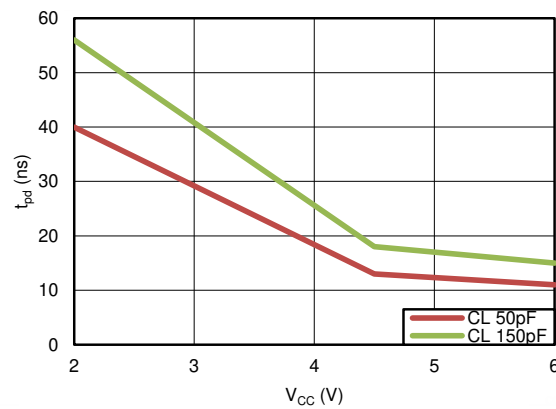
over recommended operating free-air temperature range (unless otherwise noted; see [Figure 6-1](#))

| PARAMETER | TEST CONDITIONS                            |                         | MIN  | TYP | MAX | UNIT |
|-----------|--|-------------------------|--|-----|-----|------|
| $t_{pd}$  | From A (input) to Y (output)               | $V_{CC} = 2\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 245 | ns   |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 245 |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 210 |      |
|           |  | $V_{CC} = 4.5\text{ V}$ | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 49  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 49  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 42  |      |
|           |  | $V_{CC} = 6\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 42  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 42  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 35  |      |
| $t_{en}$  | From $\overline{OE}$ (input) to Y (output) | $V_{CC} = 2\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 300 | ns   |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 300 |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 250 |      |
|           |  | $V_{CC} = 4.5\text{ V}$ | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 60  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 60  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 50  |      |
|           |  | $V_{CC} = 6\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     | 51  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     | 51  |      |
|           |  |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     | 43  |      |

over recommended operating free-air temperature range (unless otherwise noted; see [Figure 6-1](#))

| PARAMETER | TEST CONDITIONS |                         | MIN  | TYP | MAX | UNIT |    |
|-----------|-----------------|-------------------------|--|-----|-----|------|----|
| $t_t$     | To Y (output)   | $V_{CC} = 2\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 315  | ns |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 315  |    |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     |     | 265  |    |
|           |                 | $V_{CC} = 4.5\text{ V}$ | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 63   |    |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 63   |    |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     |     | 53   |    |
|           |                 | $V_{CC} = 6\text{ V}$   | $T_A = -55^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 53   |    |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $125^\circ\text{C}$ |     |     | 53   |    |
|           |                 |                         | $T_A = -40^\circ\text{C}$ to $85^\circ\text{C}$  |     |     | 45   |    |

### 5.12 Typical Characteristic



**Figure 5-1. Propagation Delay**

## 6 Parameter Measurement Information

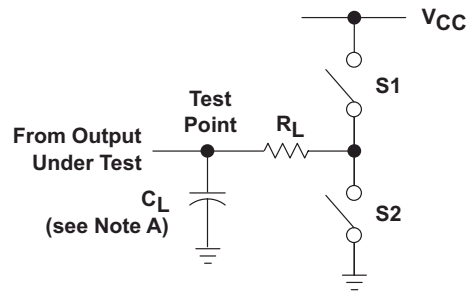


Figure 6-1. Load Circuit

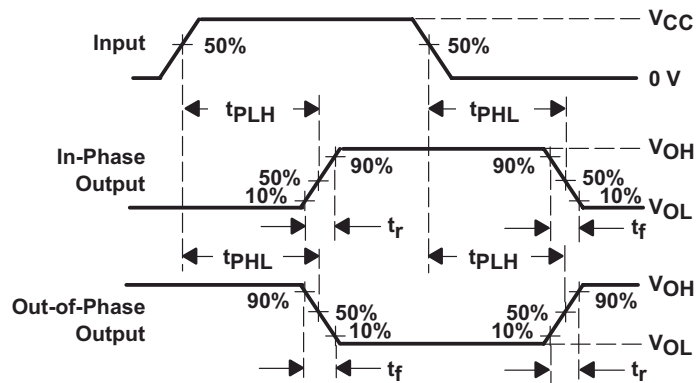


Figure 6-2. Propagation Delay and Output Transition Times

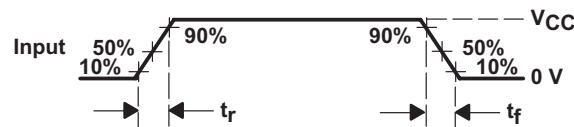


Figure 6-3. Input Rise and Fall Times

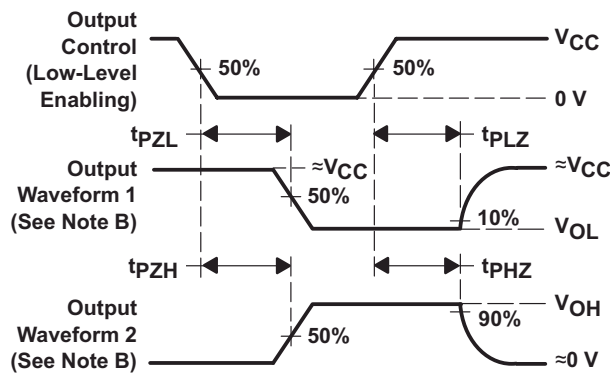


Figure 6-4. Enable and Disable Times for 3-State Outputs

### Note

NOTE:

- A.  $C_L$  includes probe and test-fixture capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 1\text{MHz}$ ,  $Z_O = 50\Omega$ ,  $t_r = 6\text{ns}$ ,  $t_f = 6\text{ns}$ .
- D. The outputs are measured one at a time with one input transition per measurement.
- E.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .
- F.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

**Table 6-1. Switching Information Table**

| PARAMETER         |           | RL          | CL            | S1     | S2     |
|-------------------|-----------|-------------|---------------|--------|--------|
| $t_{en}$          | $t_{PZH}$ | 1k $\Omega$ | 50pF or 150pF | Open   | Closed |
|                   | $t_{PZL}$ | 1k $\Omega$ | 50pF or 150pF | Closed | Open   |
| $t_{dis}$         | $t_{PHZ}$ | 1k $\Omega$ | 50pF          | Open   | Closed |
|                   | $t_{PLZ}$ | 1k $\Omega$ | 50pF          | Closed | Open   |
| $t_{pd}$ or $t_t$ |           | —           | 50pF or 150pF | Open   | Open   |

## 7 Detailed Description

### 7.1 Overview

The SNx4HC244 contains 8 individual high speed CMOS buffers organized as two 4-bit buffers/line drives with 3-state outputs.

Each buffer performs the boolean logic function  $xY_n = xA_n$ , with  $x$  being the bank number and  $n$  being the channel number.

Each output enable ( $x\overline{OE}$ ) controls four buffers. When the  $x\overline{OE}$  pin is in the low state, the outputs of all buffers in the bank  $x$  are enabled. When the  $x\overline{OE}$  pin is in the high state, the outputs of all buffers in the bank  $x$  are disabled. All disabled output are placed into the high-impedance state.

To put the device in the high-impedance state during power up or power down, tie both  $\overline{OE}$  pins to  $V_{CC}$  through a pull-up resistor; the minimum value of the resistor is determined by the current sinking capability of the driver and the leakage of the pin as defined in the *Electrical Characteristics* table.

### 7.2 Functional Block Diagram

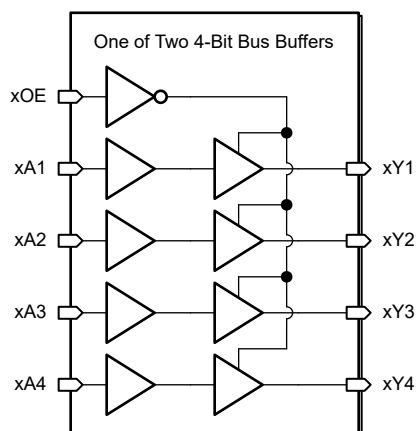


Figure 7-1. Logic Diagram (Positive Logic)

### 7.3 Feature Description

#### 7.3.1 Standard CMOS Inputs

This device includes standard CMOS inputs. Standard CMOS inputs are high impedance and are typically modeled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics*. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings*, and the maximum input leakage current, given in the *Electrical Characteristics*, using Ohm's law ( $R = V \div I$ ).

Standard CMOS inputs require that input signals transition between valid logic states quickly, as defined by the input transition time or rate in the *Recommended Operating Conditions* table. Failing to meet this specification will result in excessive power consumption and could cause oscillations. More details can be found in *Implications of Slow or Floating CMOS Inputs*.

Do not leave standard CMOS inputs floating at any time during operation. Unused inputs must be terminated at  $V_{CC}$  or GND. If a system will not be actively driving an input at all times, then a pull-up or pull-down resistor can be added to provide a valid input voltage during these times. The resistor value will depend on multiple factors; a 10k $\Omega$  resistor, however, is recommended and will typically meet all requirements.

### 7.4 Device Functional Modes

Table 7-1 lists the functional modes of the SNx4HC244.

**Table 7-1. Function Table**

| INPUTS <sup>(1)</sup> |   | OUTPUTS |
|-----------------------|---|---------|
| $\overline{OE}$       | A | Y       |
| L                     | L | L       |
| L                     | H | H       |
| H                     | X | Z       |

(1) H = High Voltage Level, L = Low Voltage Level, X = Do Not Care, Z = High-Impedance State

## 8 Application and Implementation

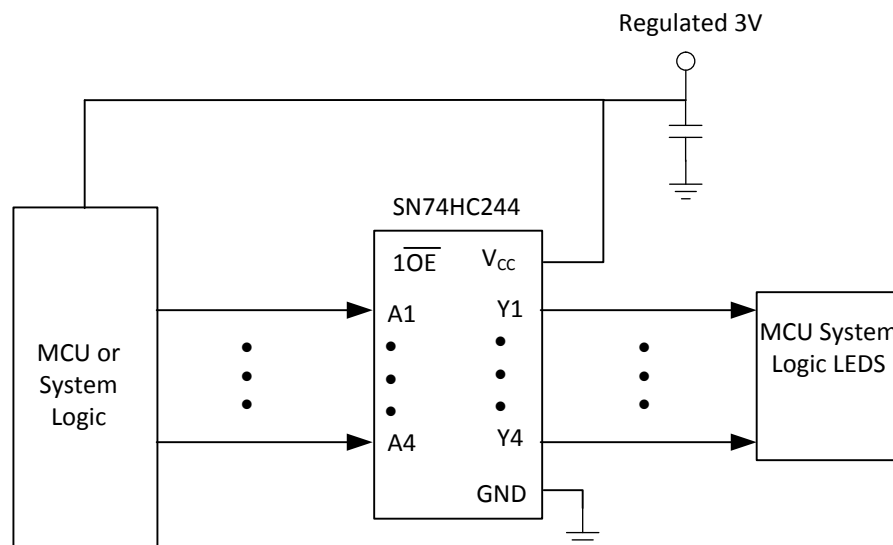
### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

SN74HC244 is a high-drive CMOS device that can be used for a multitude of bus interface type applications where output drive or PCB trace length is a concern.

### 8.2 Typical Application



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**Figure 8-1. SN74HC244 Application Schematic**

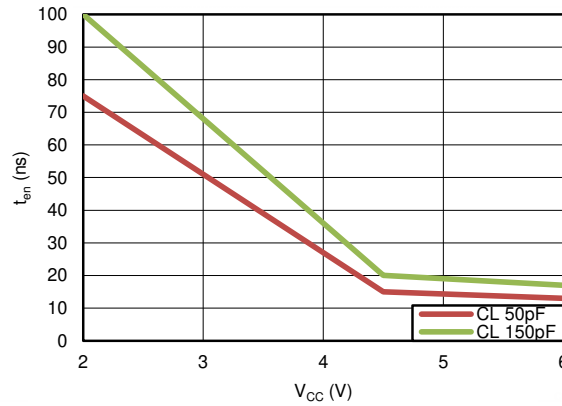
#### 8.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Take care to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive also creates fast edges into light loads so routing and load conditions should be considered to prevent ringing.

#### 8.2.2 Detailed Design Procedure

1. Recommended input conditions:
  - For rise time and fall time specifications, see  $\Delta t/\Delta V$  in [Section 5.3](#).
  - For specified high and low levels, see  $V_{IH}$  and  $V_{IL}$  in [Section 5.3](#).
2. Recommend output conditions:
  - Load currents should not exceed  $I_O$  max per output and should not exceed the continuous current through  $V_{CC}$  or GND total current for the part. These limits are located in [Section 5.1](#).
  - Outputs should not be pulled above  $V_{CC}$ .

### 8.2.3 Application Curve



**Figure 8-2. Enable Time**

### 8.3 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions*. Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance.

A  $0.1\mu\text{F}$  capacitor is recommended for this device. It is acceptable to parallel multiple bypass capacitors to reject different frequencies of noise. The  $0.1\mu\text{F}$  and  $1\mu\text{F}$  capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

### 8.4 Layout Guidelines

- Bypass capacitor placement
  - Place near the positive supply terminal of the device
  - Provide an electrically short ground return path
  - Use wide traces to minimize impedance
  - Keep the device, capacitors, and traces on the same side of the board whenever possible
- Signal trace geometry
  - 8mil to 12mil trace width
  - Lengths less than 12cm to minimize transmission line effects
  - Avoid  $90^\circ$  corners for signal traces
  - Use an unbroken ground plane below signal traces
  - Flood fill areas around signal traces with ground
  - Parallel traces must be separated by at least 3x dielectric thickness
  - For traces longer than 12cm
    - Use impedance controlled traces
    - Source-terminate using a series damping resistor near the output
    - Avoid branches; buffer each signal that must branch separately

#### 8.4.1 Layout Example

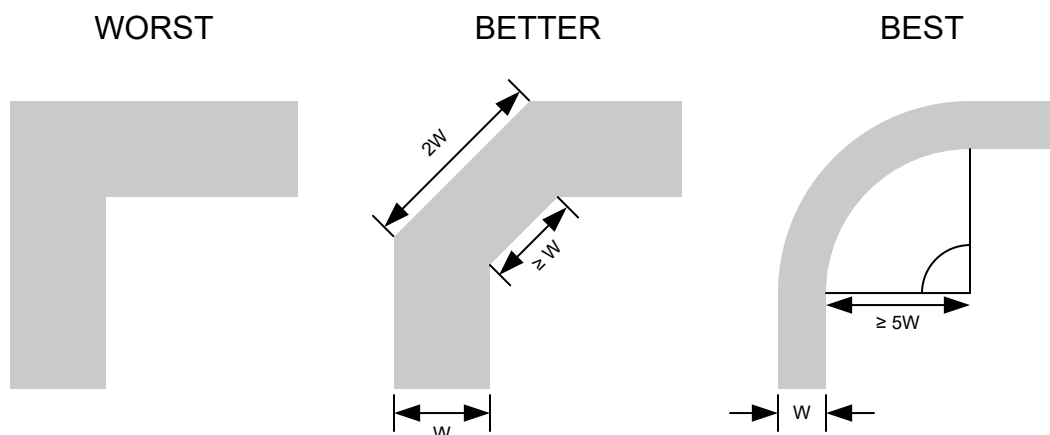
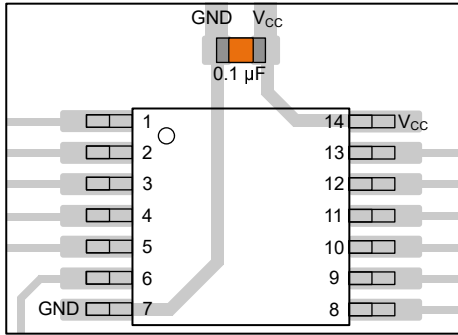
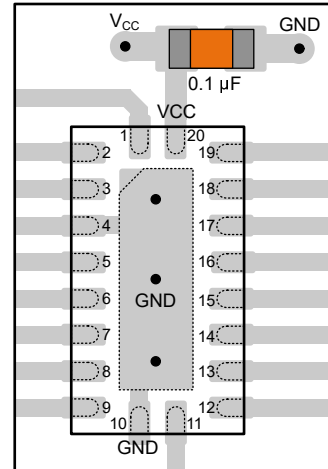


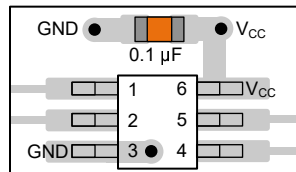
Figure 8-3. Example Trace Corners for Improved Signal Integrity



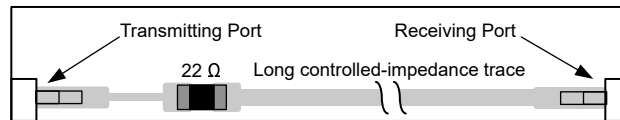
**Figure 8-4. Example Bypass Capacitor Placement for TSSOP and Similar Packages**



**Figure 8-5. Example Bypass Capacitor Placement for WQFN and Similar Packages**



**Figure 8-6. Example Bypass Capacitor Placement for SOT, SC70 and Similar Packages**



**Figure 8-7. Example Damping Resistor Placement for Improved Signal Integrity**

## 9 Device and Documentation Support

### 9.1 Documentation Support

#### 9.1.1 Documentation Support

- Texas Instruments, [Implications of Slow or Floating CMOS Inputs](#) application note
- Texas Instruments, [Semiconductor and IC Package Thermal Metrics](#) application note

### 9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on [ti.com](http://ti.com). Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.3 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

### 9.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.

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### 9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 9.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

## 10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision H (February 2025) to Revision I (January 2026) Page

- |   |   |
|---|---|
| • Updated SN74HC244 operating temperature from: 85°C to: 125°C..... | 4 |
|---|---|

### Changes from Revision G (January 2025) to Revision H (February 2025) Page

- |  |   |
|--|---|
| • Updated SN74HC244 values in <i>Electrical Characteristics</i> table, <i>Recommended Operating Conditions</i> table, and <i>Switching Characteristics</i> tables..... | 1 |
|--|---|

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number            | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                |
|----------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|------------------------------------|
| <a href="#">5962-8409601VRA</a>  | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8409601VR<br>A<br>SNV54HC244J |
| 5962-8409601VRA.A                | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8409601VR<br>A<br>SNV54HC244J |
| <a href="#">5962-8409601VSA</a>  | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8409601VS<br>A<br>SNV54HC244W |
| 5962-8409601VSA.A                | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8409601VS<br>A<br>SNV54HC244W |
| <a href="#">84096012A</a>        | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 84096012A<br>SNJ54HC<br>244FK      |
| <a href="#">8409601RA</a>        | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601RA<br>SNJ54HC244J           |
| <a href="#">8409601SA</a>        | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601SA<br>SNJ54HC244W           |
| <a href="#">JM38510/65705B2A</a> | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705B2A               |
| JM38510/65705B2A.A               | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705B2A               |
| <a href="#">JM38510/65705BRA</a> | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BRA               |
| JM38510/65705BRA.A               | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BRA               |
| <a href="#">JM38510/65705BSA</a> | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BSA               |
| JM38510/65705BSA.A               | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BSA               |
| <a href="#">M38510/65705B2A</a>  | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705B2A               |

| Orderable part number               | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)           |
|-------------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------|
| <a href="#">M38510/65705BRA</a>     | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BRA          |
| <a href="#">M38510/65705BSA</a>     | Active        | Production           | CFP (W)   20    | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | JM38510/<br>65705BSA          |
| <a href="#">SN54HC244J</a>          | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | SN54HC244J                    |
| <a href="#">SN54HC244J.A</a>        | Active        | Production           | CDIP (J)   20   | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | SN54HC244J                    |
| <a href="#">SN74HC244APWR</a>       | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244A                        |
| <a href="#">SN74HC244APWR.A</a>     | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244A                        |
| <a href="#">SN74HC244DBR</a>        | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DBR.A</a>      | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DWR</a>        | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DWR.A</a>      | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DWRE4</a>      | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DWRG4</a>      | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244DWRG4.A</a>    | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244N</a>          | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | SN74HC244N                    |
| <a href="#">SN74HC244N.A</a>        | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | SN74HC244N                    |
| <a href="#">SN74HC244NE4</a>        | Active        | Production           | PDIP (N)   20   | 20   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | SN74HC244N                    |
| <a href="#">SN74HC244NSR</a>        | Active        | Production           | SOP (NS)   20   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244NSR.A</a>      | Active        | Production           | SOP (NS)   20   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244NSRG4</a>      | Active        | Production           | SOP (NS)   20   | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PW</a>         | Obsolete      | Production           | TSSOP (PW)   20 | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PWR</a>        | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PWR.A</a>      | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PWRE4</a>      | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PWRG4</a>      | Active        | Production           | TSSOP (PW)   20 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244                         |
| <a href="#">SN74HC244PWT</a>        | Obsolete      | Production           | TSSOP (PW)   20 | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | HC244                         |
| <a href="#">SN74HC244QDWRG4Q1</a>   | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 125   | HC244Q                        |
| <a href="#">SN74HC244QDWRG4Q1.A</a> | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | HC244Q                        |
| <a href="#">SNJ54HC244FK</a>        | Active        | Production           | LCCC (FK)   20  | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 84096012A<br>SNJ54HC<br>244FK |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)           |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-------------------------------|
| SNJ54HC244FK.A              | Active        | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 84096012A<br>SNJ54HC<br>244FK |
| <a href="#">SNJ54HC244J</a> | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601RA<br>SNJ54HC244J      |
| SNJ54HC244J.A               | Active        | Production           | CDIP (J)   20  | 20   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601RA<br>SNJ54HC244J      |
| <a href="#">SNJ54HC244W</a> | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601SA<br>SNJ54HC244W      |
| SNJ54HC244W.A               | Active        | Production           | CFP (W)   20   | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 8409601SA<br>SNJ54HC244W      |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF SN54HC244, SN54HC244-SP, SN74HC244 :**

- Catalog : [SN74HC244](#), [SN54HC244](#)
  
- Automotive : [SN74HC244-Q1](#), [SN74HC244-Q1](#)
  
- Enhanced Product : [SN74HC244-EP](#), [SN74HC244-EP](#)
  
- Military : [SN54HC244](#)
  
- Space : [SN54HC244-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
  
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects
  
- Enhanced Product - Supports Defense, Aerospace and Medical Applications
  
- Military - QML certified for Military and Defense Applications
  
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**

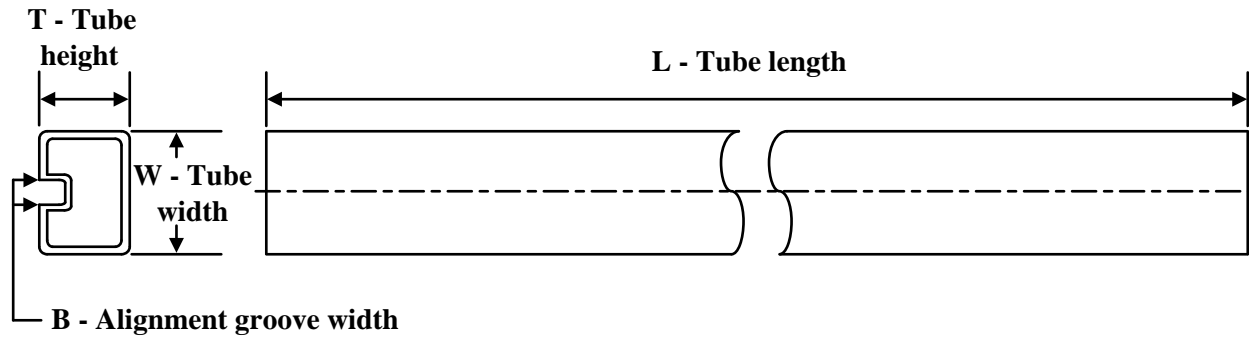

\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74HC244APWR     | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| SN74HC244DBR      | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| SN74HC244DWR      | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74HC244DWR      | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.9    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74HC244DWRG4    | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |
| SN74HC244NSR      | SOP          | NS              | 20   | 2000 | 330.0              | 24.4               | 8.4     | 13.0    | 2.5     | 12.0    | 24.0   | Q1            |
| SN74HC244PWR      | TSSOP        | PW              | 20   | 2000 | 330.0              | 16.4               | 6.95    | 7.0     | 1.4     | 8.0     | 16.0   | Q1            |
| SN74HC244QDWRG4Q1 | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74HC244APWR     | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74HC244DBR      | SSOP         | DB              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74HC244DWR      | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74HC244DWR      | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74HC244DWRG4    | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74HC244NSR      | SOP          | NS              | 20   | 2000 | 356.0       | 356.0      | 45.0        |
| SN74HC244PWR      | TSSOP        | PW              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| SN74HC244QDWRG4Q1 | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |

**TUBE**


\*All dimensions are nominal

| Device             | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|--------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-8409601VSA    | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| 5962-8409601VSA.A  | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| 84096012A          | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| 8409601SA          | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| JM38510/65705B2A   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| JM38510/65705B2A.A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| JM38510/65705BSA   | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| JM38510/65705BSA.A | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| M38510/65705B2A    | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| M38510/65705BSA    | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SN74HC244N         | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC244N.A       | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SN74HC244NE4       | N            | PDIP         | 20   | 20  | 506    | 13.97  | 11230  | 4.32   |
| SNJ54HC244FK       | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54HC244FK.A     | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| SNJ54HC244W        | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |
| SNJ54HC244W.A      | W            | CFP          | 20   | 25  | 506.98 | 26.16  | 6220   | NA     |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

## GENERIC PACKAGE VIEW

**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4229370VA\

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

# DW0020A



# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220724/A 05/2016

**NOTES:**

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

DW0020A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

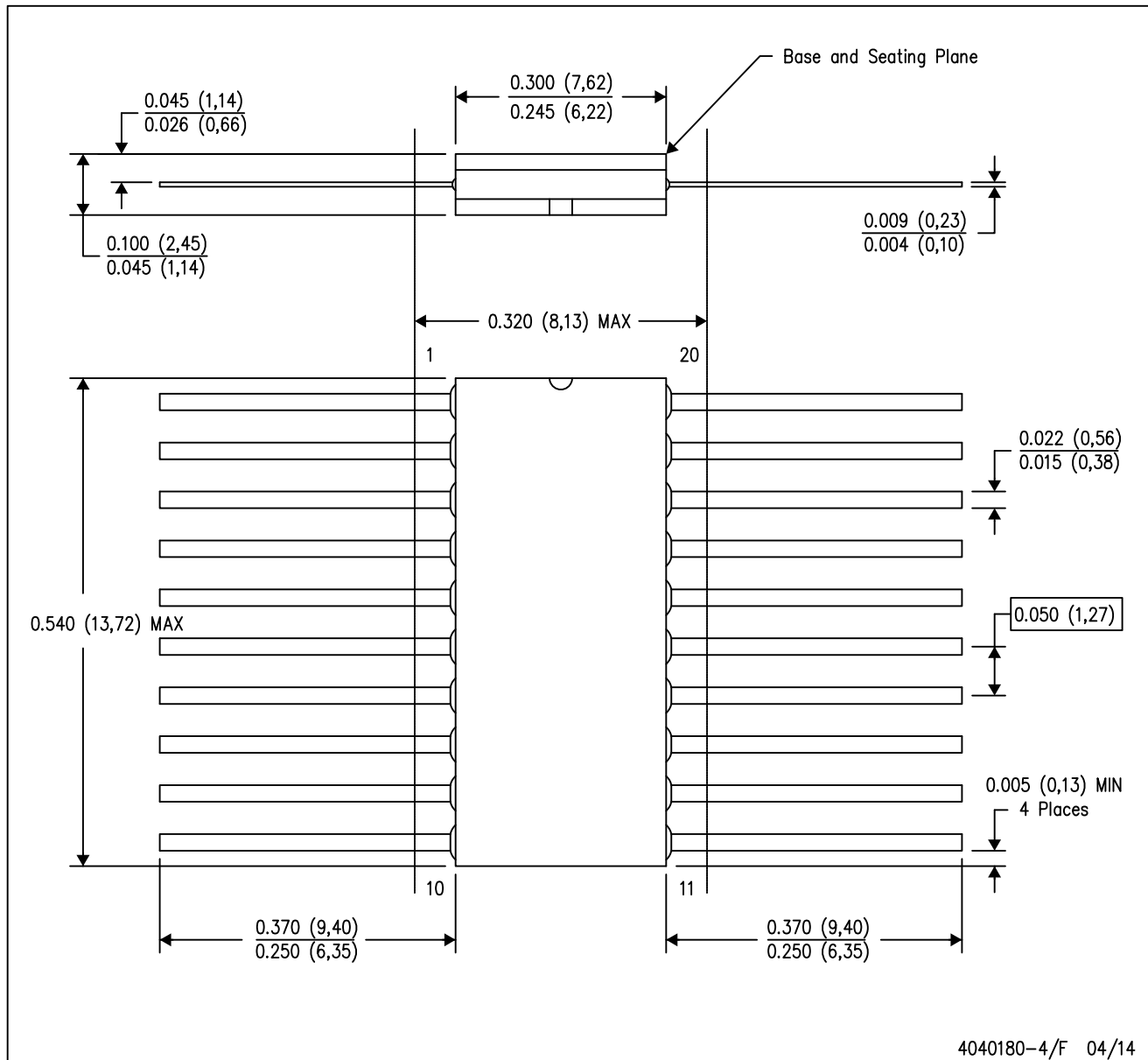
4220724/A 05/2016

NOTES: (continued)

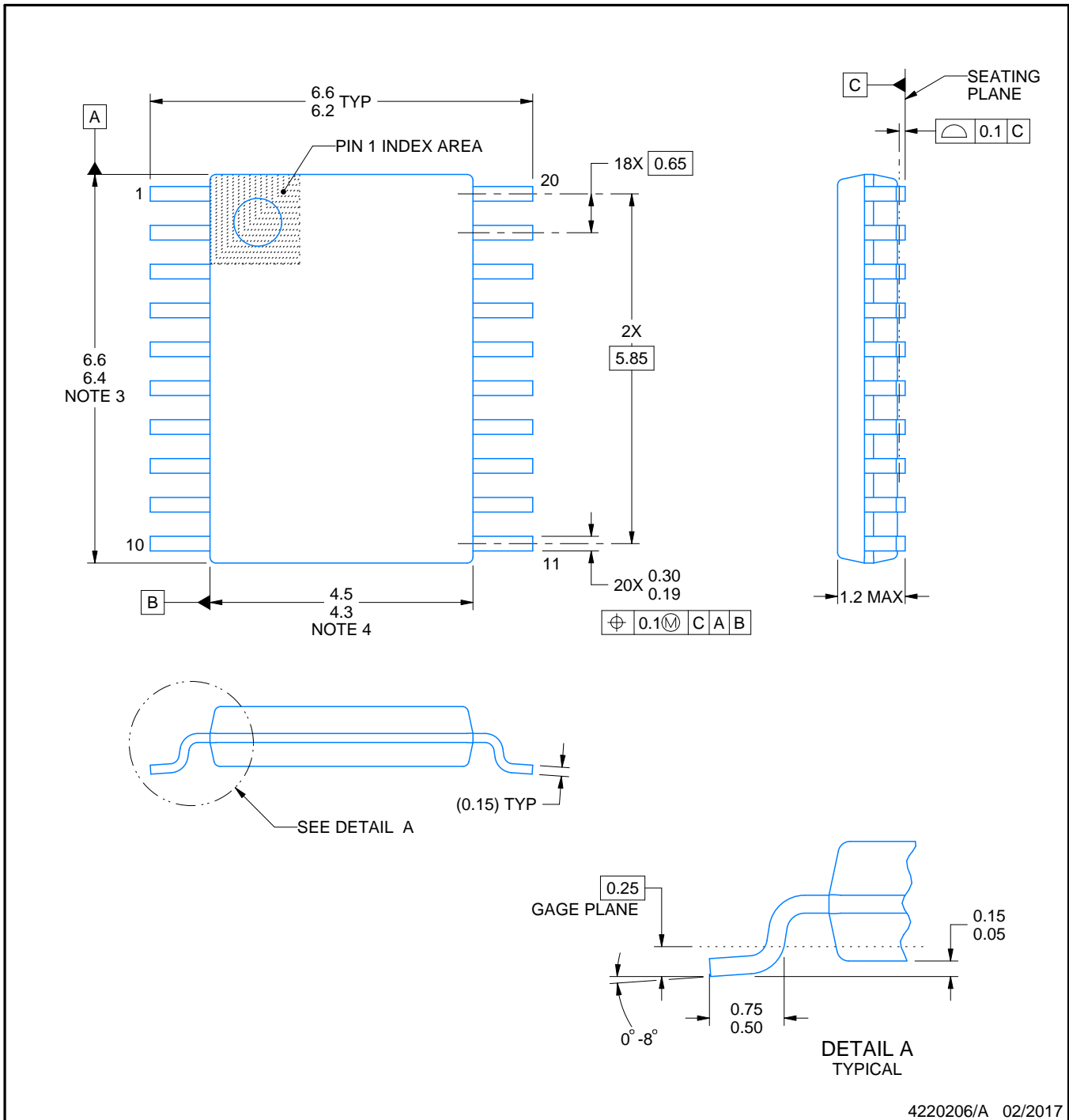
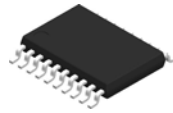
8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

W (R-GDFP-F20)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within Mil-Std 1835 GDFP2-F20



4220206/A 02/2017

NOTES:

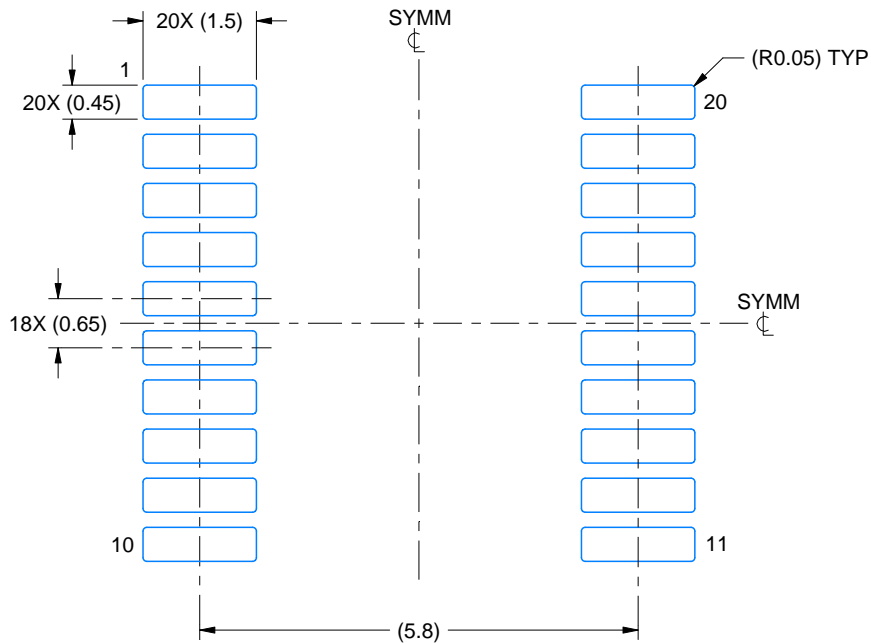
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220206/A 02/2017

NOTES: (continued)

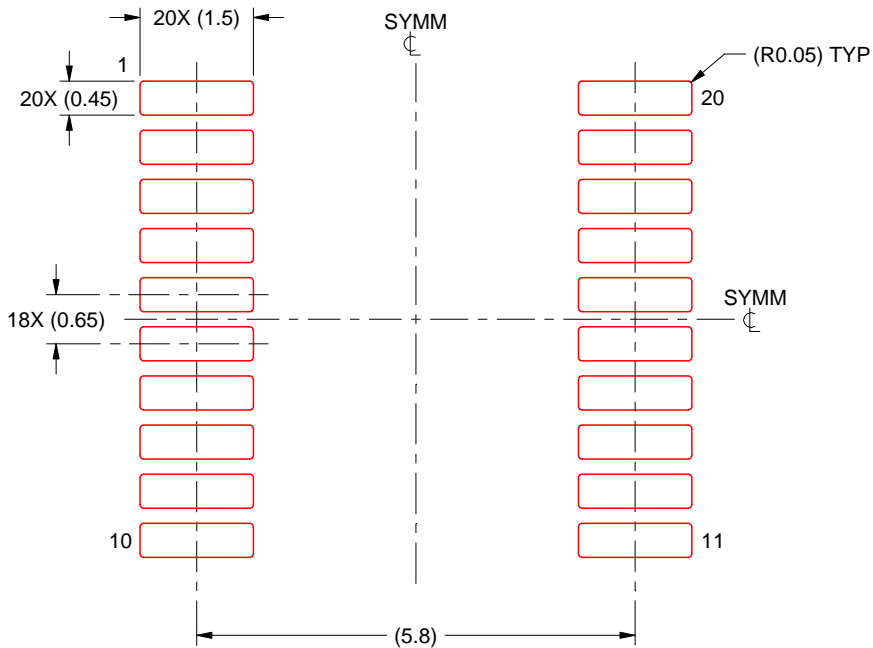
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



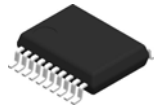
SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

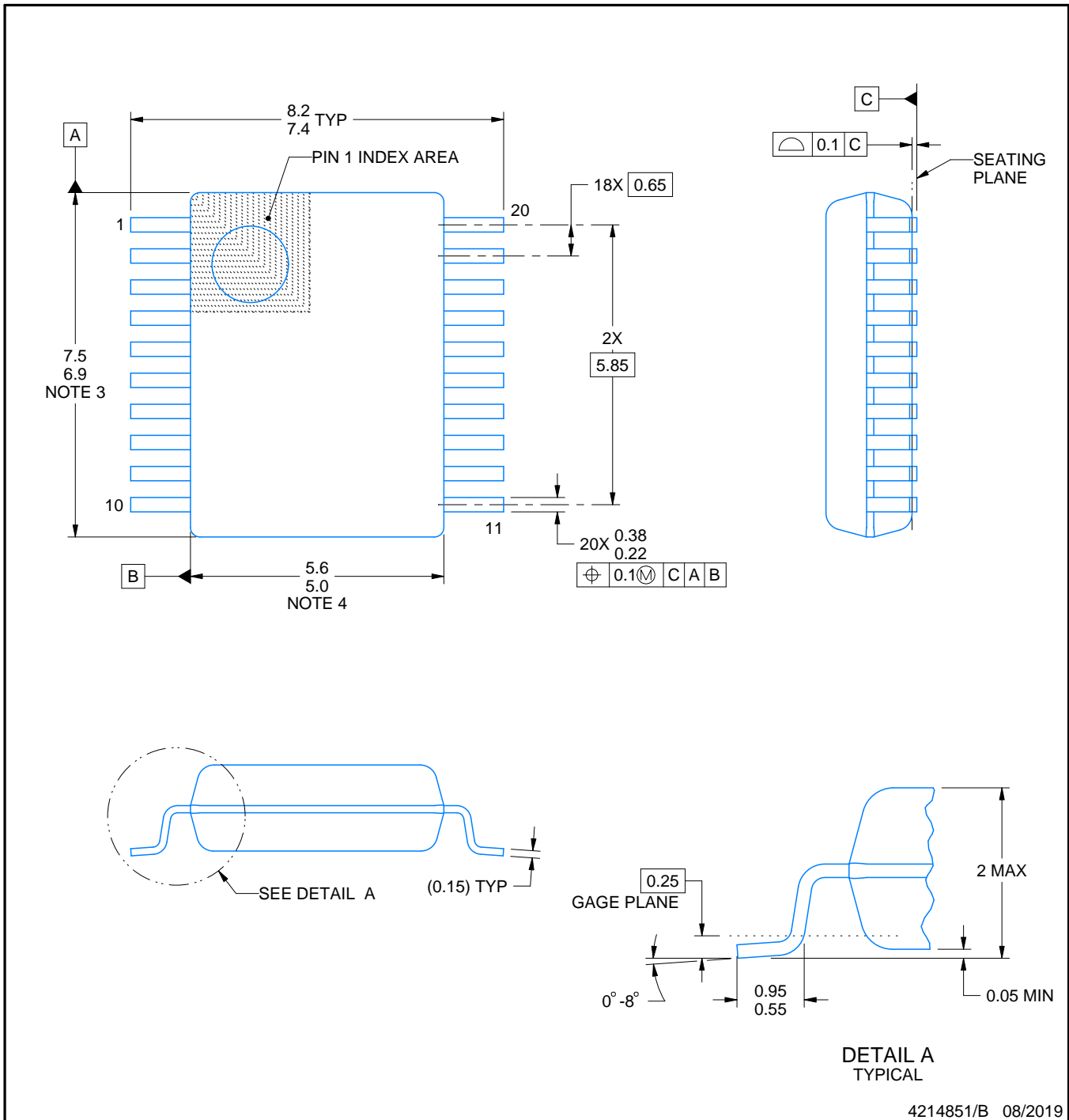
# DB0020A



# PACKAGE OUTLINE

## SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



4214851/B 08/2019

### NOTES:

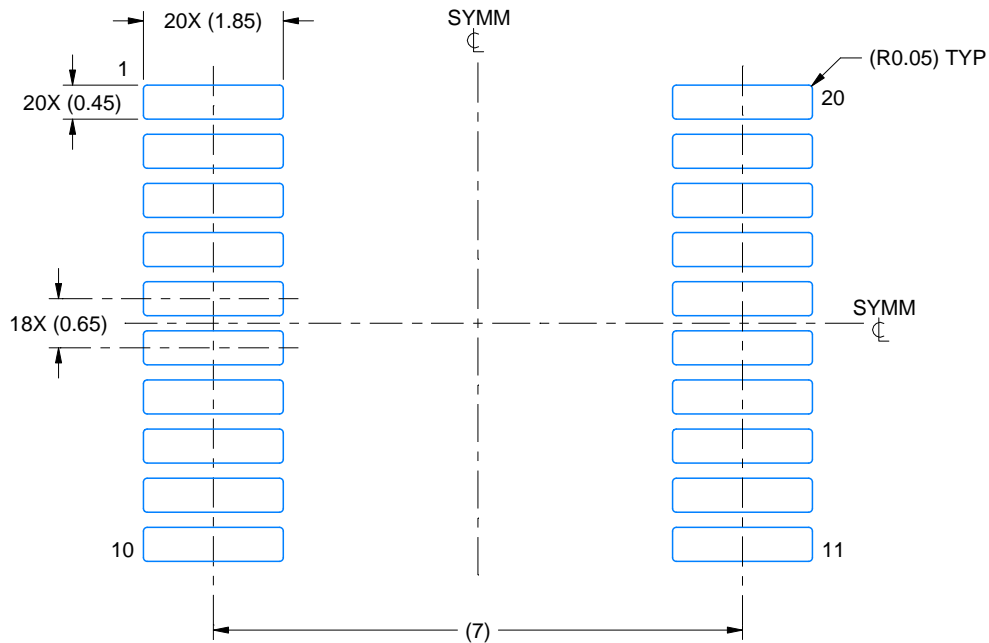
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

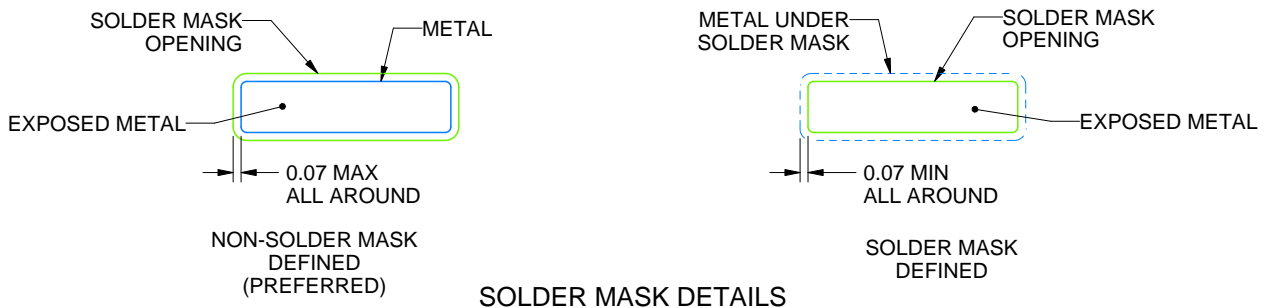
DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



4214851/B 08/2019

NOTES: (continued)

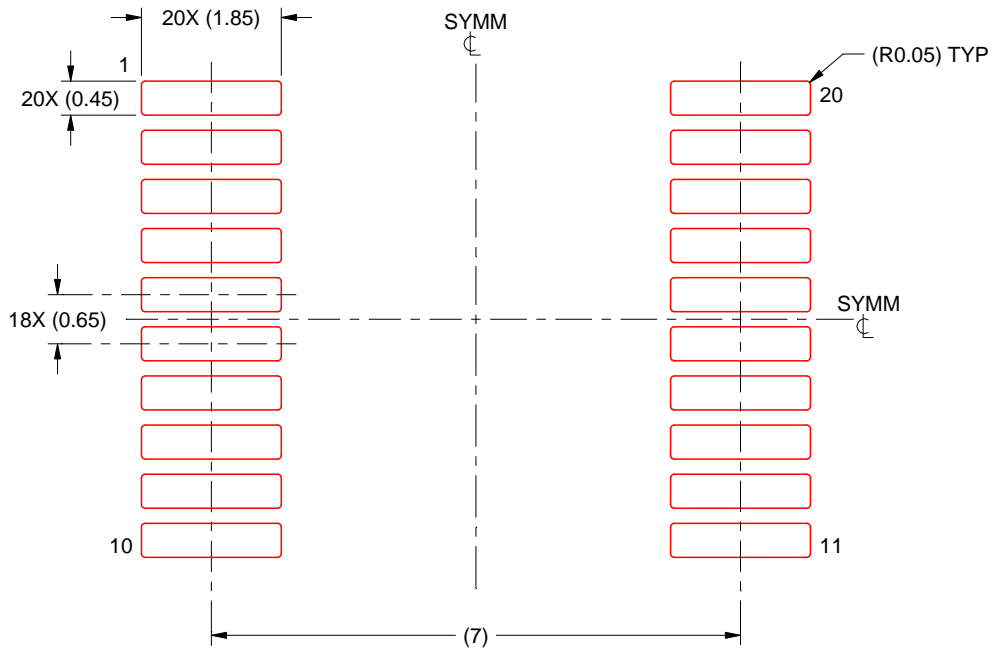
- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4214851/B 08/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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